

PCN M401: for Singapore Qualcomm CSSP Backend relocation

Old ordering code:

B39*B12*

New ordering code:

B39*B7*

Customer part number:

B39*B8*

B39*B9*

Description of change:

With the expansion of Qualcomm® CSSP™ capacity in Wuxi, China, as indicated in Product Change Notification (M398), Qualcomm will enable the present 3 Qualcomm production facilities (Singa. H, I, J) in Singapore to be consolidated into a single building (Singa. H). All processes and equipment, remaining in Singapore, will be relocated to Singa. H building; hence, vertically integrating our production flow within one single facility. Personnel operating these equipment remains unchanged and will be deployed in Singa. H building.

Effect on the product or for the customer (benefit / quality, specification, lead time):

The relocation of equipment and other materials from Singa. I and Singa. J buildings to Singa. H building has no effect on ordering codes, specifications, form factor, performance, quality, or lead times.

Customer samples can be ordered on request.

Quality assurance measures / risk assessment:

Test data, and samples of representative types for all product families will be provided upon request from May 2022.
Qualification data based on Qualcomm test procedures to be available from July 2022 onwards.

Contact

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Customers are asked to address inquiries directly to their sales contacts.

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Qualcomm

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